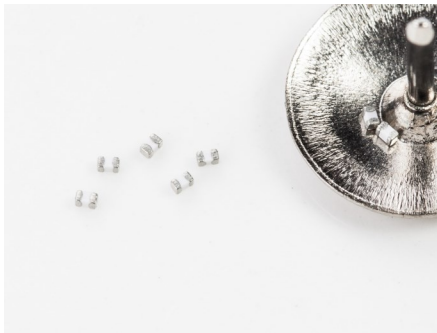


SolidMatrix® Surface Mount Fuses

FA Series (Fast Acting), 0402 Size



Features:

- Multilayer monolithic structure with glass ceramic body and silver fusing element.
- Silver termination with nickel and pure-tin solder plating, providing excellent solderability.
- Compatible with both wave and reflow soldering processes.
- Operating temperature range: -55°C to +150°C (with de-rating).
- Wide current rating from 0.5A up to 8A.
- High power density at 0402 chip size which is ideal for the miniaturization and space saving.

Clearing Time Characteristics:

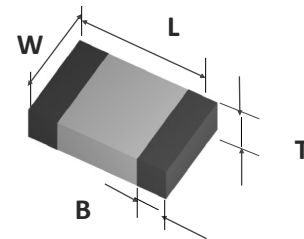
% of current rating	Clearing time at 25°C
100%	4 hours min.
250%	5 seconds max.
400%	0.05 seconds max.

Shape and Dimensions:

Unit	Inch	mm
L	0.039 ± 0.004	1.00 ± 0.10
W	0.020 ± 0.004	0.51 ± 0.10
T	0.020 ± 0.004	0.51 ± 0.10
B	0.010 ± 0.004	0.25 ± 0.10

Applications:

- Panel
- Notebook
- Toy
- HDD
- IoT
- Finger print
- Smart lock
- Battery pack



Ordering Information:

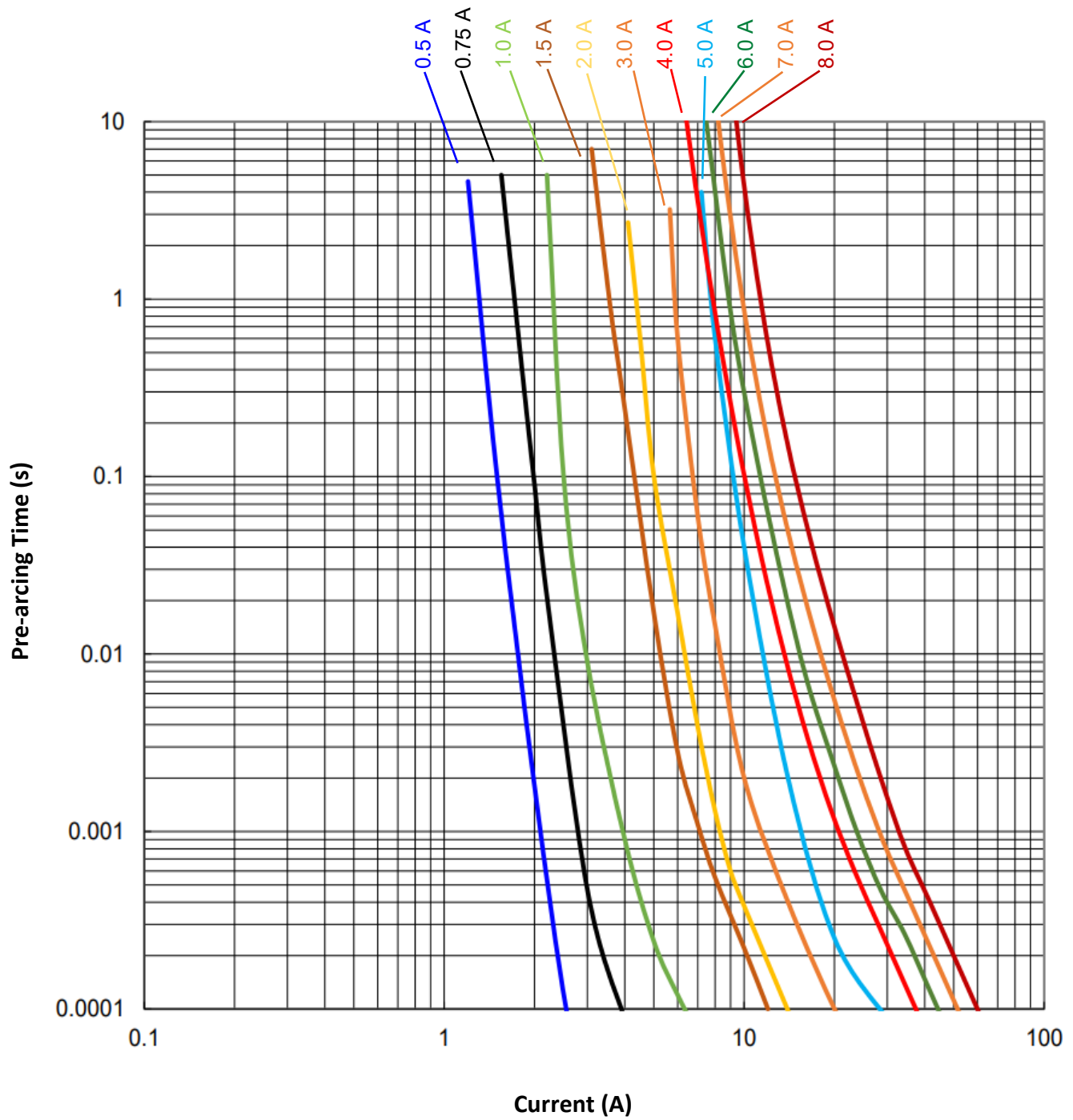
Part Number	Current Rating (A)	Voltage Rating (Vdc)	Interrupting Ratings	Nominal Cold DCR (Ω) ¹	Nominal I ² t (A ² s) ²	Agency Approval
F0402FA0500V024T	0.5	24	35 A at rated voltage	0.380	0.004	UL No.E232989
F0402FA0750V024T	0.75	24		0.210	0.007	UL No.E232989
F0402FA1000V024T	1.0	24		0.120	0.014	UL No.E232989
F0402FA1500V024T	1.5	24		0.056	0.050	UL No.E232989
F0402FA2000V024T	2.0	24		0.035	0.070	UL No.E232989
F0402FA3000V024T	3.0	24		0.021	0.11	UL No.E232989
F0402FA4000V024T	4.0	24		0.014	0.21	UL No.E232989
F0402FA5000V024T	5.0	24		0.011	0.45	Pending
F0402FA6000V024T	6.0	24		0.010	0.55	Pending
F0402FA7000V024T	7.0	24		0.008	0.80	Pending
F0402FA8000V024T	8.0	24		0.007	1.00	Pending

1. Measured at ≤ 10% rated current and 25°C ambient.

2. Melting I²t at 0.001 second pre-arcing time.

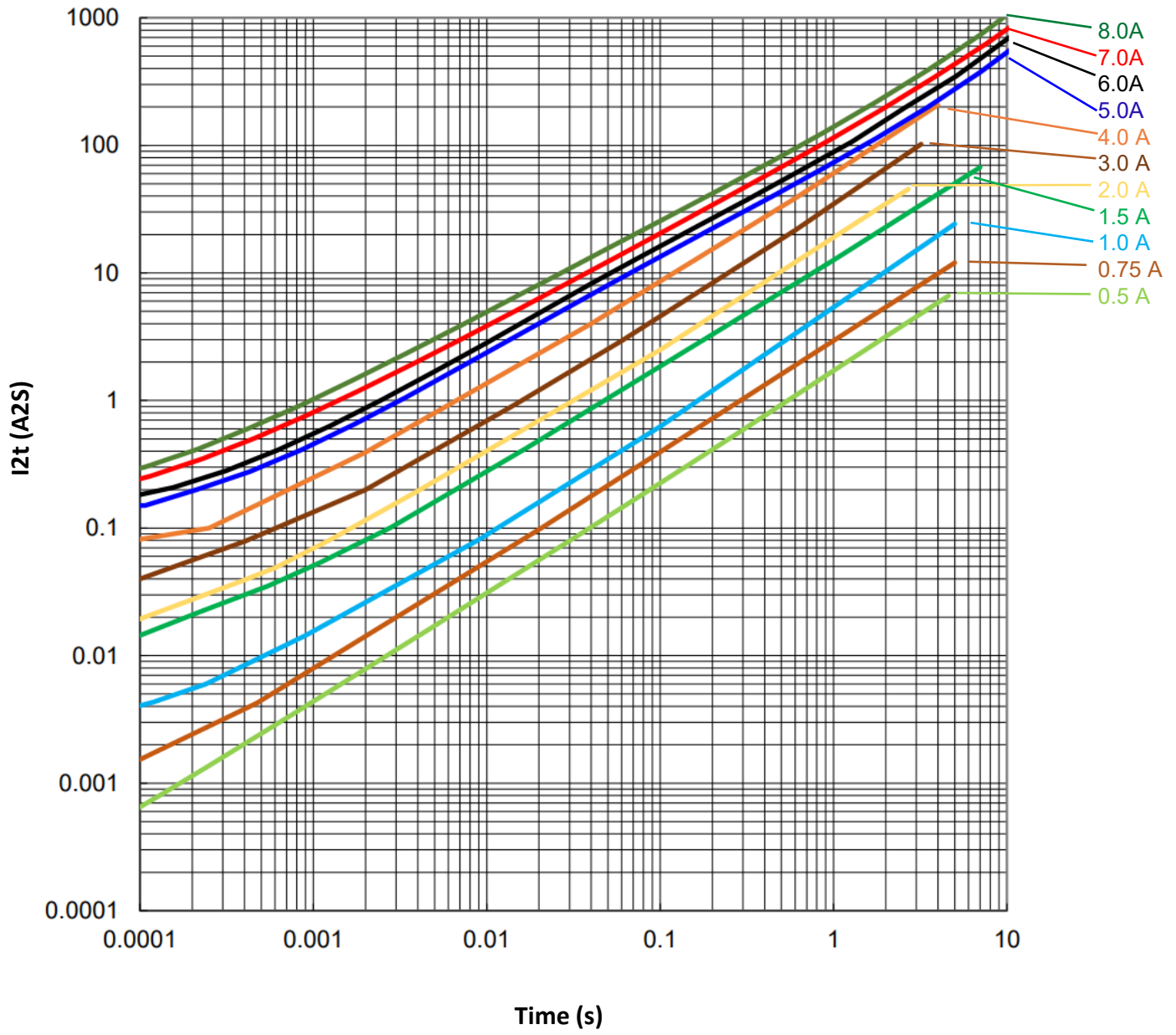
SolidMatrix® Surface Mount Fuses
FA Series (Fast Acting), 0402 Size

Average Pre-arcing Time Curves:



SolidMatrix[®] Surface Mount Fuses
FA Series (Fast Acting), 0402 Size

Average I^2t vs. t Curves:



SolidMatrix[®] Surface Mount Fuses

Electrical Specification:

Clearing Time Characteristics:

Same as specified on the Short Form Data Sheet

Insulation Resistance after Opening:

20,000 ohms typical when cleared with rated voltage applied. Fuse clearing under low voltage conditions may result in lower after clearing insulation resistance values. (Note: Under normal fault conditions (low or rated voltage conditions), AEM SolidMatrix fuses provide sufficient after clearing insulation resistance values for circuit protection.)

Current Carrying Capacity:

100% rated current at +25°C ambient for 4 hours minimum when evaluated per MIL-PRF-23419

Interrupt Ratings:

Same as specified in this catalog.

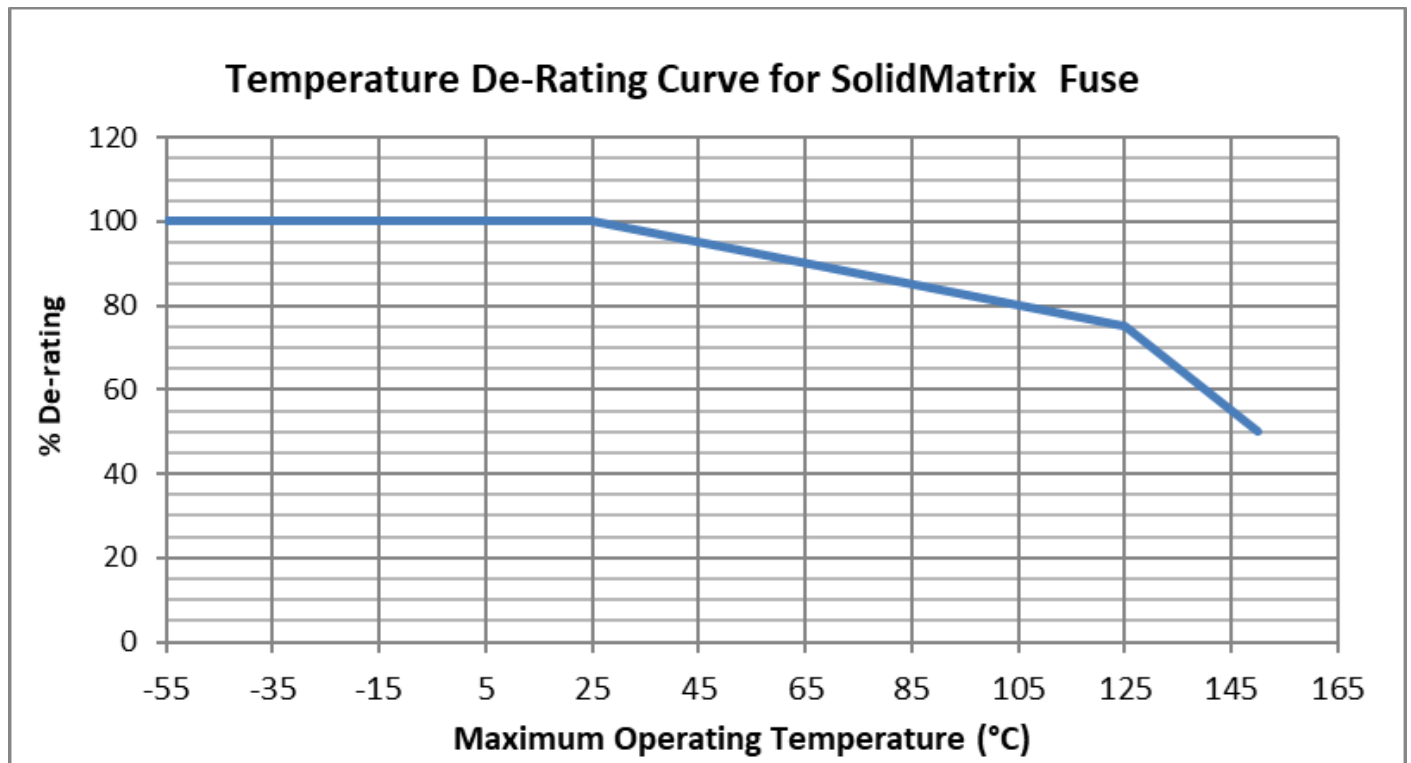
Fuse Selection and Temperature De-rating Guideline:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be “de-rated”.

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature.

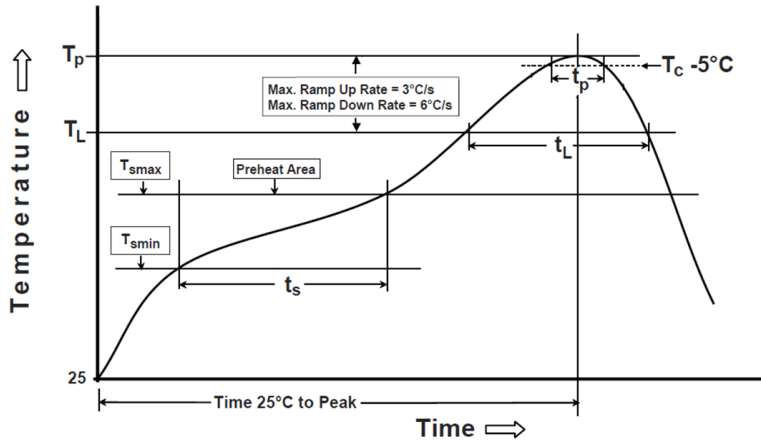
Example: At maximum operating temperature of 65°C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be: $4 / 0.75 / 90\% = 5.9$ or 6 A. Specifications and descriptions in this literature are as accurate as known at the time of publish, but are subject to change without notice.



SolidMatrix® Surface Mount Fuses

Soldering Temperature Profile:

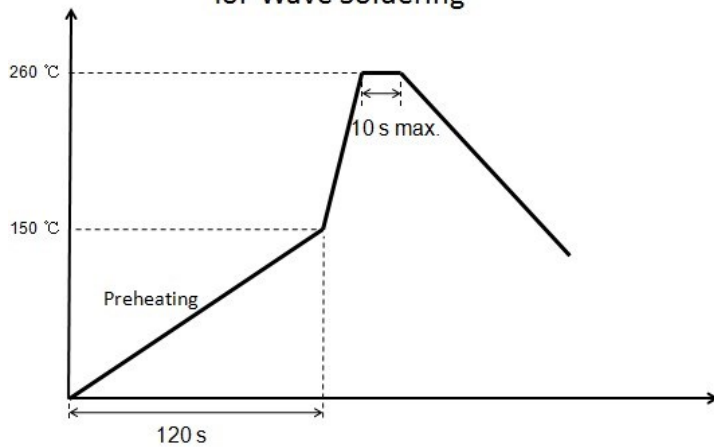
* Recommended Temperature Profile for Reflow Soldering



Profile Feature	Pb-Free Assembly
Preheat/Soak	
Temperature Min (T_{smin})	150°C
Temperature Max (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60~120 seconds
Ramp-up rate (T_L to T_p)	3°C/second max.
Liquidous temperature (T_L)	217°C
Time (t_L) maintained above T_L	60~150 seconds
Peak package body temperature (T_p)	260°C
Time (t_p)* within 5°C of the specified classification temperature (T_c)	30 seconds *
Ramp-down rate (T_p to T_L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.
* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum	

* Recommended Temperature Profile for Wave Soldering

Recommended Temperature Profile for Wave Soldering



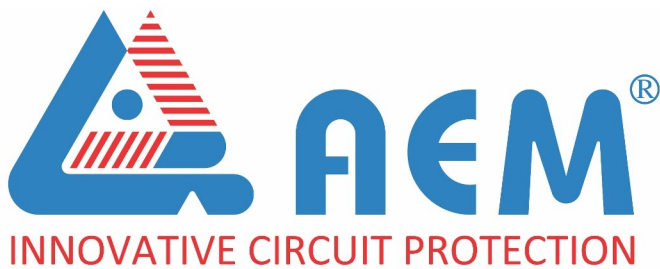
Notice: Wave Soldering is suitable for 1206 and 0603 size.

Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel
0402 (1005)	10,000
0603 (1608)	4,000
0603FF (1608)	6,000
1206 (3216)	3,000

Disclaimer

Specifications are subject to change without notice. AEM products are designed for specific applications and should not be used for any purpose (including, without limitation, automotive, aerospace, medical, life-saving applications, or any other application which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property) not expressly set forth in applicable AEM product documentation. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Warranties granted by AEM shall be deemed void for products used for any purpose not expressly set forth in applicable AEM product documentation. AEM shall not be liable for any claims or damages arising out of products used in applications not expressly intended by AEM as set forth in applicable AEM product documentation. The sale and use of AEM products is subject to AEM terms and conditions of sale. Please refer to AEM's website for updated catalog and terms and conditions of sale.



AEM Components (Suzhou) Co., Ltd

**461 Zhongnan Street,
China-Singapore Suzhou Industrial Park
Jiangsu, P. R. China, 215026**

Tel: 86-512-6258-0028

Fax: 86-512-6258-0018

Email: marketing@aemchina.com

AEM Components (USA), Inc.

6670 Cobra Way, San Diego, CA 92121, USA

Tel: 1-858-750-6100

Fax: 1-858-481-1123

Email: sales@aemcomponents.com